

Standard Rectifier Module

1~ Rectifier	
$V_{RRM} =$	800 V
$I_{DAV} =$	160 A
$I_{FSM} =$	2800 A

1~ Rectifier Bridge

Part number

VBO160-08NO7



 E72873



Features / Advantages:

- Package with DCB ceramic
- Improved temperature and power cycling
- Planar passivated chips
- Very low forward voltage drop
- Very low leakage current

Applications:

- Diode for main rectification
- For one phase bridge configurations
- Supplies for DC power equipment
- Input rectifiers for PWM inverter
- Battery DC power supplies
- Field supply for DC motors

Package: PWS-E

- Isolation Voltage: 3000 V~
- Industry standard outline
- RoHS compliant
- Easy to mount with two screws
- Base plate: Copper internally DCB isolated
- Advanced power cycling

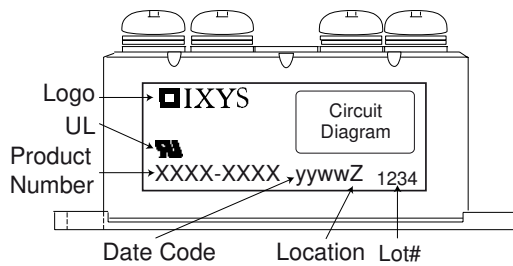
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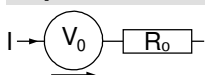


Rectifier				Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit
V_{RSM}	max. non-repetitive reverse blocking voltage					900	V
V_{RRM}	max. repetitive reverse blocking voltage					800	V
I_R	reverse current	$V_R = 800\text{ V}$		$T_{VJ} = 25^\circ\text{C}$		200	μA
		$V_R = 800\text{ V}$		$T_{VJ} = 150^\circ\text{C}$		3.5	mA
V_F	forward voltage drop	$I_F = 160\text{ A}$		$T_{VJ} = 25^\circ\text{C}$		1.07	V
		$I_F = 320\text{ A}$				1.22	V
		$I_F = 160\text{ A}$		$T_{VJ} = 125^\circ\text{C}$		0.96	V
		$I_F = 320\text{ A}$				1.15	V
I_{DAV}	bridge output current	$T_C = 110^\circ\text{C}$		$T_{VJ} = 150^\circ\text{C}$		160	A
		rectangular	d = 0.5				
V_{FO}	threshold voltage			$T_{VJ} = 150^\circ\text{C}$		0.74	V
r_F	slope resistance					2.4	m Ω
						} for power loss calculation only	
R_{thJC}	thermal resistance junction to case					0.4	K/W
R_{thCH}	thermal resistance case to heatsink				0.15		K/W
P_{tot}	total power dissipation			$T_C = 25^\circ\text{C}$		310	W
I_{FSM}	max. forward surge current	t = 10 ms; (50 Hz), sine		$T_{VJ} = 45^\circ\text{C}$		2.80	kA
		t = 8,3 ms; (60 Hz), sine		$V_R = 0\text{ V}$		3.03	kA
		t = 10 ms; (50 Hz), sine		$T_{VJ} = 150^\circ\text{C}$		2.38	kA
		t = 8,3 ms; (60 Hz), sine		$V_R = 0\text{ V}$		2.57	kA
I^2t	value for fusing	t = 10 ms; (50 Hz), sine		$T_{VJ} = 45^\circ\text{C}$		39.2	kA ² s
		t = 8,3 ms; (60 Hz), sine		$V_R = 0\text{ V}$		38.1	kA ² s
		t = 10 ms; (50 Hz), sine		$T_{VJ} = 150^\circ\text{C}$		28.3	kA ² s
		t = 8,3 ms; (60 Hz), sine		$V_R = 0\text{ V}$		27.5	kA ² s
C_J	junction capacitance	$V_R = 400\text{ V}; f = 1\text{ MHz}$		$T_{VJ} = 25^\circ\text{C}$		133	pF

Package PWS-E				Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit	
I_{RMS}	RMS current	per terminal			250	A	
T_{VJ}	virtual junction temperature		-40		150	°C	
T_{op}	operation temperature		-40		125	°C	
T_{stg}	storage temperature		-40		125	°C	
Weight					273	g	
M_D	mounting torque		4.25		5.75	Nm	
M_T	terminal torque		4.25		5.75	Nm	
$d_{Spp/App}$	creepage distance on surface striking distance through air	terminal to terminal	12.0			mm	
$d_{Spb/Apb}$		terminal to backside	26.0			mm	
V_{ISOL}	isolation voltage	t = 1 second	3000			V	
		t = 1 minute	2500			V	



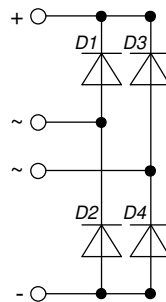
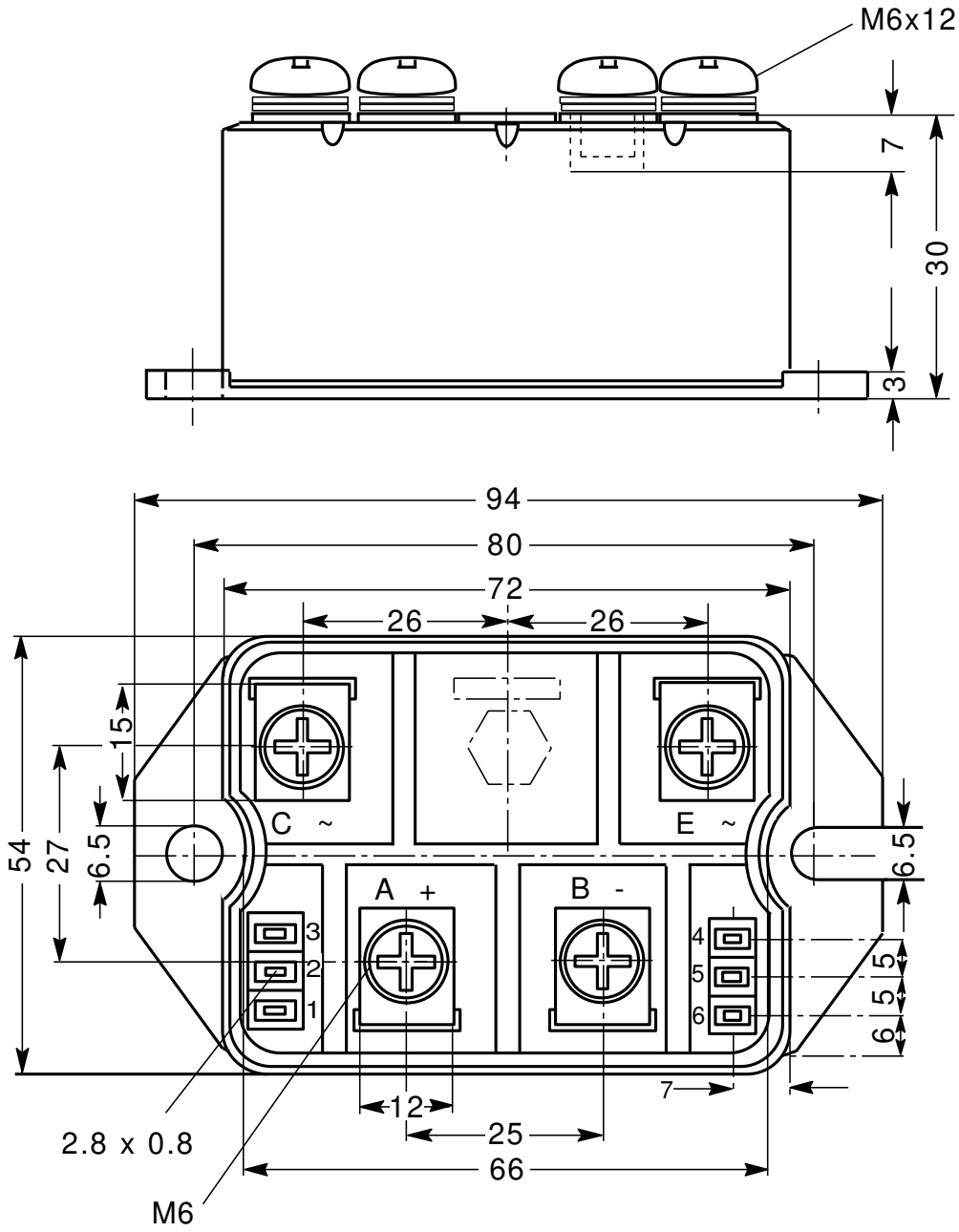
Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	VBO160-08NO7	VBO160-08NO7	Box	5	475785

Equivalent Circuits for Simulation
** on die level*
 $T_{VJ} = 150^{\circ}\text{C}$

Rectifier

$V_{0\ max}$	threshold voltage	0.74	V
$R_{0\ max}$	slope resistance *	1.2	mΩ



Outlines PWS-E



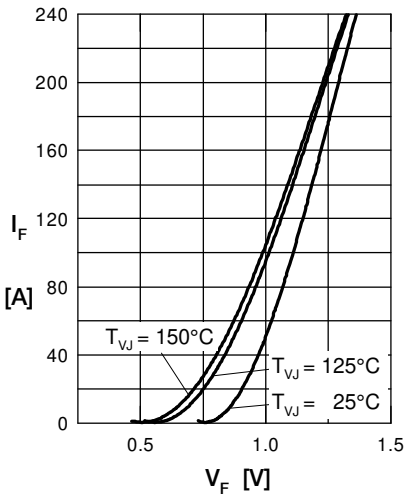
Rectifier


Fig. 1 Forward current vs. voltage drop per diode

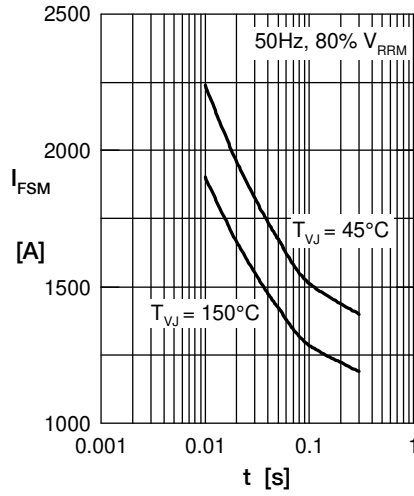


Fig. 2 Surge overload current vs. time per diode

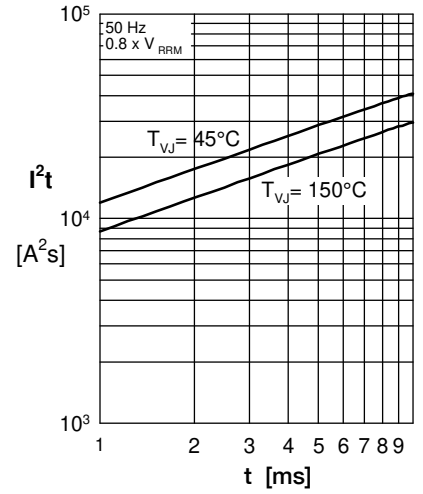
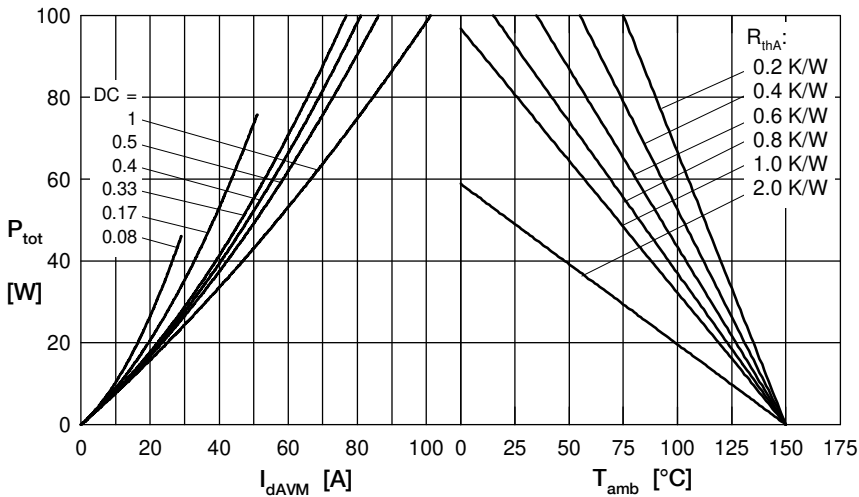

 Fig. 3 I^2t vs. time per diode


Fig. 4 Power dissipation vs. forward current and ambient temperature per diode

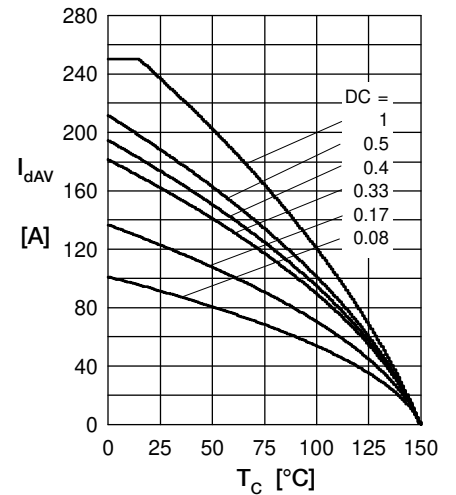


Fig. 5 Max. forward current vs. case temperature per diode

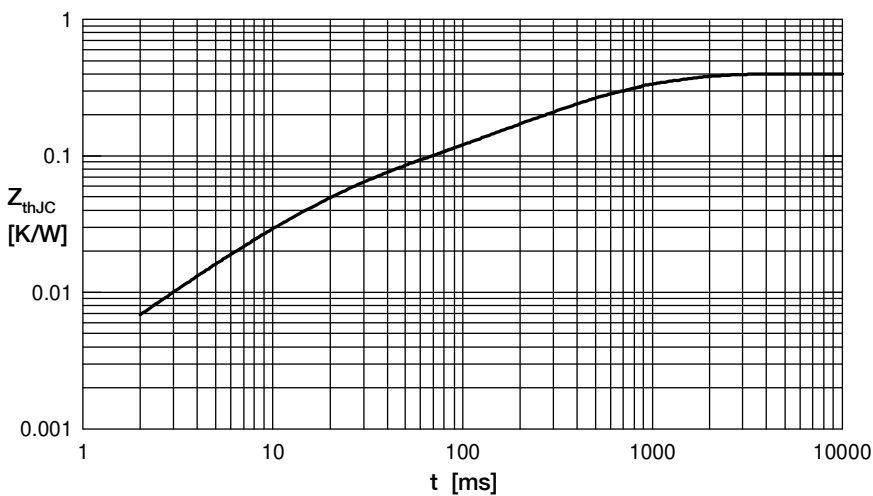


Fig. 6 Transient thermal impedance junction to case vs. time per diode

